

STL76DN4LF7AG

Automotive-grade dual N-channel 40 V, 5 mΩ typ., 40 A STripFET™ F7 Power MOSFET in a PowerFLAT™ 5x6 DI

Datasheet - production data

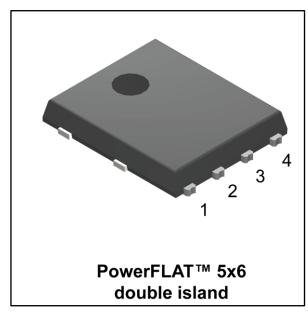
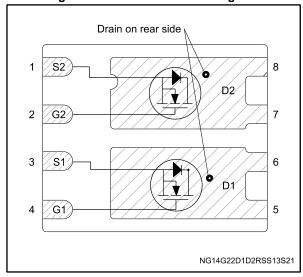


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ID	
STL76DN4LF7AG	40 V	6 mΩ	40 A	



- AEC-Q101 qualified
- Among the lowest R_{DS(on)} on the market
- Excellent FoM (figure of merit)
- Low C_{rss}/C_{iss} ratio for EMI immunity
- High avalanche ruggedness
- Wettable flank package

Applications

• Switching applications

Description

This dual N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

Table 1: Device summary

		<u> </u>	
Order code	Marking	Package	Packing
STL76DN4LF7AG	76DN4LF7	PowerFLAT [™] 5x6 double island	Tape and reel

July 2017 DocID029186 Rev 5 1/16

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STL76DN4LF7AG Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	40	V
V _{GS}	Gate-source voltage	±20	V
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	40	Α
I _D ⁽¹⁾	Drain current (continuous) at T _c = 100 °C	40	Α
I _{DM} ⁽²⁾	Drain current (pulsed) 160		Α
Ртот	Total dissipation at T _C = 25 °C	71	W
Tj	Operating junction temperature range		°C
T _{stg}	-55 to 175 brage temperature range		°C

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	2.1	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	32	°C/W

Notes:

⁽¹⁾Drain current is limited by package, the current capability of the silicon is 79 A at 25 °C and 56 A at 100 °C.

⁽²⁾Pulse width limited by safe operating area.

 $^{^{(1)}}$ When mounted on FR-4 board of 1 inch², 2oz Cu, t < 10 s.

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 4: On/Off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}$	40			V
I _{DSS}	Zero gate voltage drain current	V _{GS} = 0 V V _{DS} = 40 V			10	μΑ
I _{GSS}	Gate-body leakage current	V _{GS} = ±20 V, V _{DS} = 0 V			100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.5		2.5	V
D	Static drain-source	V _{GS} = 10 V, I _D = 10 A		5	6	mΩ
R _{DS(on)}	on-resistance	V _{GS} = 4.5 V, I _D = 10 A		7	12	11177

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	956	1	
Coss	Output capacitance	$V_{DS} = 25 \text{ V, f} = 1 \text{ MHz,}$	-	241	ı	pF
Crss	Reverse transfer capacitance	V _{GS} = 0 V		28	ı	ρ.
Qg	Total gate charge	$V_{DD} = 20 \text{ V}, I_D = 20 \text{ A},$	-	17	ı	
Q_{gs}	Gate-source charge	V _{GS} = 0 to 10 V (see <i>Figure 14</i> :	-	3.2	ı	nC
Q_{gd}	Gate-drain charge	"Test circuit for gate charge behavior")	-	4.3	-	

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 32 \text{ V}, I_D = 10 \text{ A},$	ı	9	ı	
t _r	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see		4.3	-	
t _{d(off)}	Turn-off delay time	Figure 13: "Test circuit for resistive load switching times"	ı	39	1	ns
t _f	Fall time	and Figure 18: "Switching time waveform")	-	10	-	

Table 7: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD} ⁽¹⁾	Source-drain current		ı		40	Α
I _{SDM} ⁽²⁾	Source-drain current (pulsed)		-		160	Α
V _{SD} ⁽³⁾	Forward on voltage	I _{SD} = 40 A, V _{GS} = 0 V	-		1.3	V
t _{rr}	Reverse recovery time	I _{SD} = 20 A, di/dt = 100 A/μs,	ı	27		ns
Qrr	Reverse recovery charge	V _{DD} = 32 V (see Figure 15: "Test circuit for inductive load	-	19.5		nC
I _{RRM}	Reverse recovery current	switching and diode recovery times")	-	1.4		Α

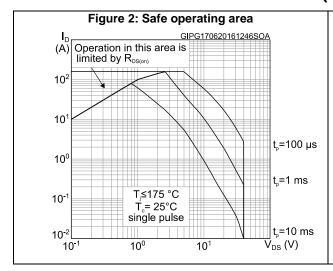
Notes:

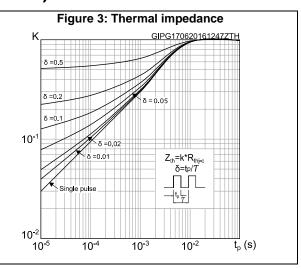
 $^{^{(1)}\}mbox{D}\mbox{rain current}$ is limited by package, the current capability of the silicon is 79 A at 25 °C.

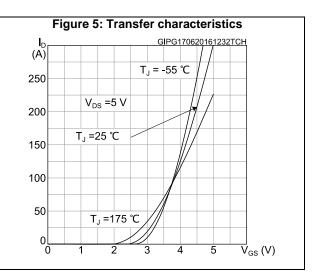
 $[\]ensuremath{^{(2)}}\mbox{Pulse}$ width limited by safe operating area .

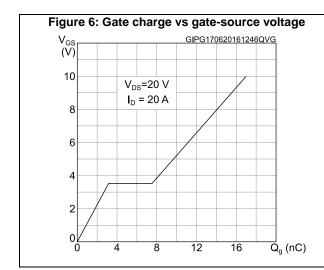
 $^{^{(3)}\}text{Pulsed:}$ pulse duration = 300 $\mu\text{s,}$ duty cycle 1.5%.

2.1 Electrical characteristics (curves)









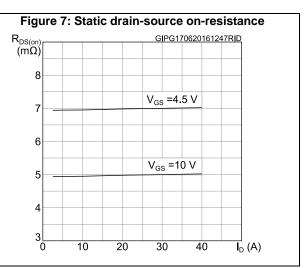


Figure 8: Capacitance variations

C GIPG170620161244CVR

103

C CISS

C COSS

1002

F = 1 MHz

C CRSS

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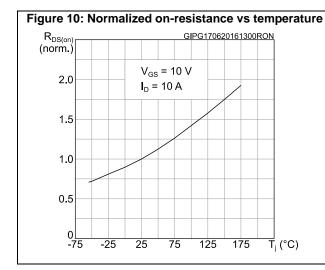
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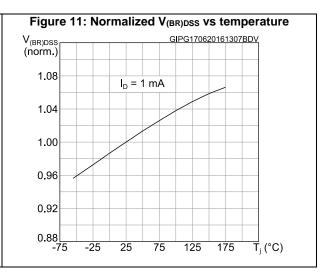
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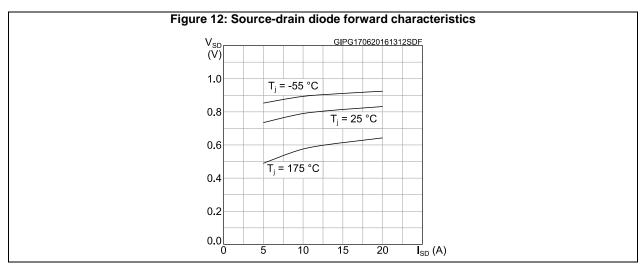
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1010

Figure 9: Normalized gate threshold voltage vs temperature V_{GS(th)} (norm.) GIPG170620161302VTH 1.2 $I_D = 250 \, \mu A$ 1.0 0.8 0.6 0.4 0.2 -25 25 125 175 T_i (°C) 75







Test circuits STL76DN4LF7AG

3 Test circuits

Figure 13: Test circuit for resistive load switching times

Figure 14: Test circuit for gate charge behavior

12 V 47 KΩ 100 Ω D.U.T.

12 V 47 KΩ VGD

14 VGD

14 VGD

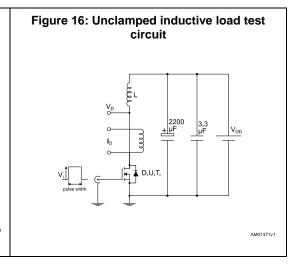
15 VGD

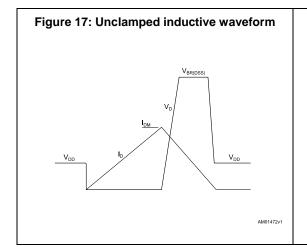
16 CONST 100 Ω D.U.T.

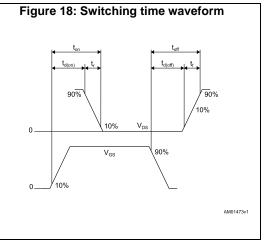
17 VGD

18 V

Figure 15: Test circuit for inductive load switching and diode recovery times







4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

PowerFLAT 5x6 double island WF type C package 4.1 information

Figure 19: PowerFLAT™ 5x6 double island WF type C package outline

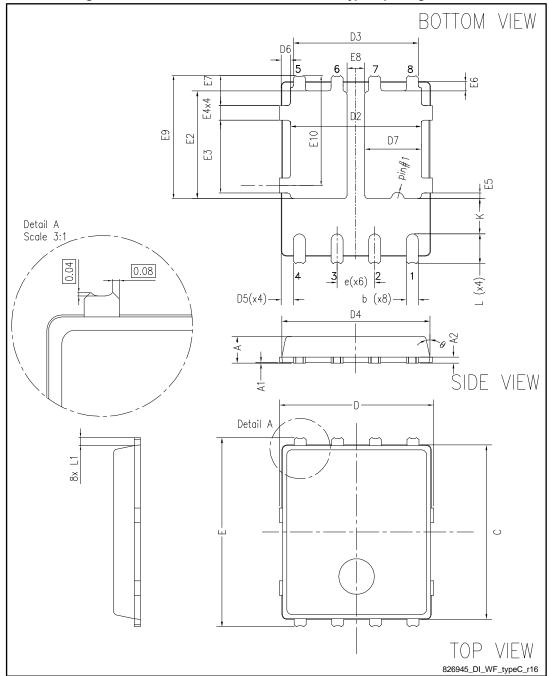


Table 8: PowerFLAT™ 5x6 double island WF type C mechanical data

Dim.		mm	
Dim.	Min.	Тур.	Max.
Α	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
С	5.80	6.00	6.10
D	5.00	5.20	5.40
D2	4.15		4.45
D3	4.05	4.20	4.35
D4	4.80	5.00	5.10
D5	0.25	0.40	0.55
D6	0.15	0.30	0.45
D7	1.68		1.98
е		1.27	
Е	6.20	6.40	6.60
E2	3.50		3.70
E3	2.35		2.55
E4	0.40		0.60
E5	0.08		0.28
E6	0.20	0.325	0.45
E7	0.85	1.00	1.15
E8	0.55		0.75
E9	4.00	4.20	4.40
E10	3.55	3.70	3.85
L	0.90	1.00	1.10
L1	0.175	0.275	0.375
K	1.05		1.35
θ	0°		12°

5,40 4,60 3,15 1,90 0,40

Figure 20: PowerFLAT™ 5x6 double island recommended footprint (dimensions are in mm)

4.2 Packing information

Figure 21: PowerFLAT™ 5x6 WF tape (dimensions are in mm)

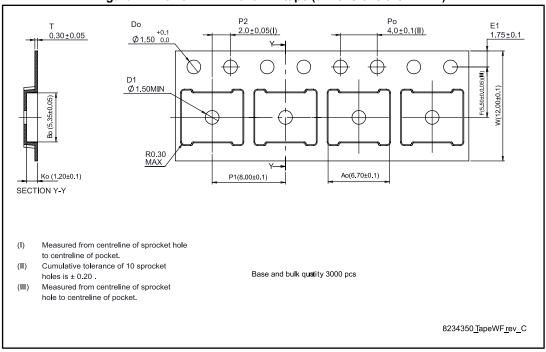
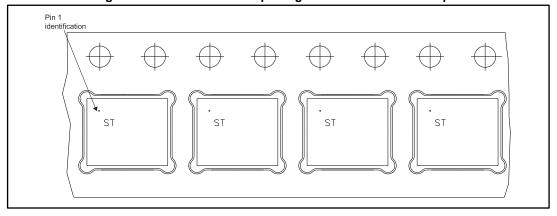


Figure 22: PowerFLAT™ 5x6 package orientation in carrier tape



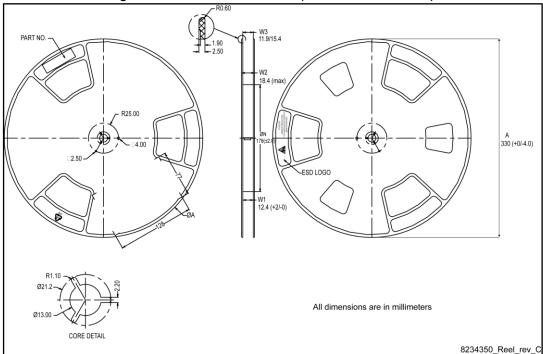


Figure 23: PowerFLAT™ 5x6 reel (dimensions are in mm)

STL76DN4LF7AG Revision history

5 Revision history

Table 9: Document revision history

Date	Revision	Changes
20-Apr-2016	1	First release.
23-Jun-2016	2	Modified: title, features and description in cover page. Modified: Table 4: "On/Off states", Table 5: "Dynamic", Table 6: "Switching times" and Table 7: "Source-drain diode". Added: Section 4.1: "Electrical characteristics (curves)". Updated: Section 6.1: "PowerFLAT 5x6 double island WF type C package information". Minor text changes
27-Jul-2016	3	Updated Table 4: "On/Off states".
16-Dec-2016	4	Updated Section 4: "Package information". Minor text changes
27-Jul-2017	5	Updated title and features in cover page. Document status updated from preliminary to production data.

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